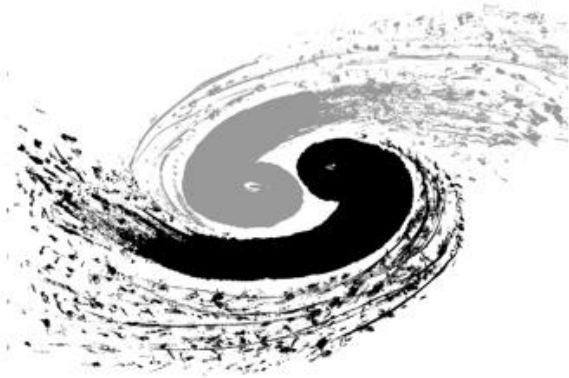


Development progress of LO&CLK distribution RTM board

GAO Wenbin (高文斌), GAN Nan (甘楠), MA Xinpeng (马新朋),
MU Yajie (牟雅洁), PENG Yongyi (彭永宜), LI Jingyi (李京祎)



LINAC Group, Accelerator Center
Institute of High Energy Physics, CAS
2025-9-15

Outline

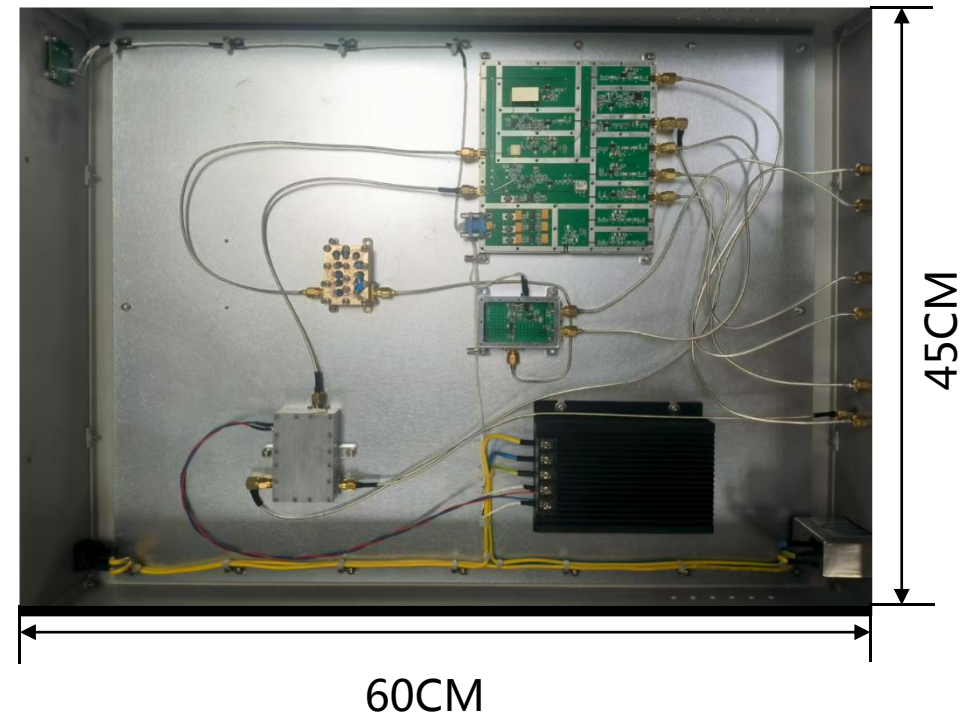
- Motivation
- Design, progress and status
- Future plans

Motivation

- at IHEP, several types accelerators, different frequencies, BEPCII: 2856MHz / 571.2MHz / 142.8MHz, HEPS: 2998.8MHz / 499.8MHz / 166.6MHz, CEPC 9cell SC/NC: 1.3GHz / 650MHz / 2860MHz / 5720MHz many different LLRF
- LO/CLK and RF front-end are different for these projects, should be modular and least change among develop and maintainence

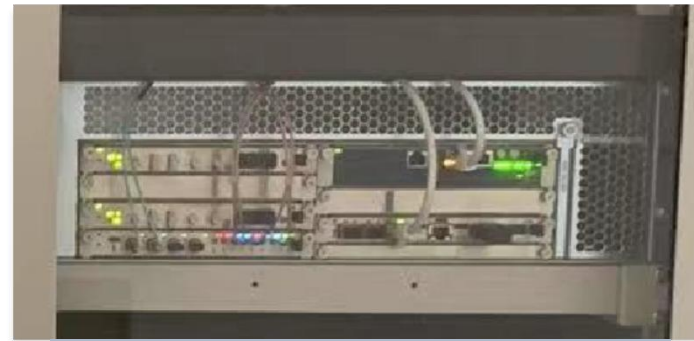
Motivation

- Now LO&CLK modules used are standalone 'box' with limited temperature stability and not fully monitored and manageable
- Change of LO/CLK due to temp/humi not easy fully monitored and calibrated even using "reference tracking"
- LO&CLK shall be absolutely stable

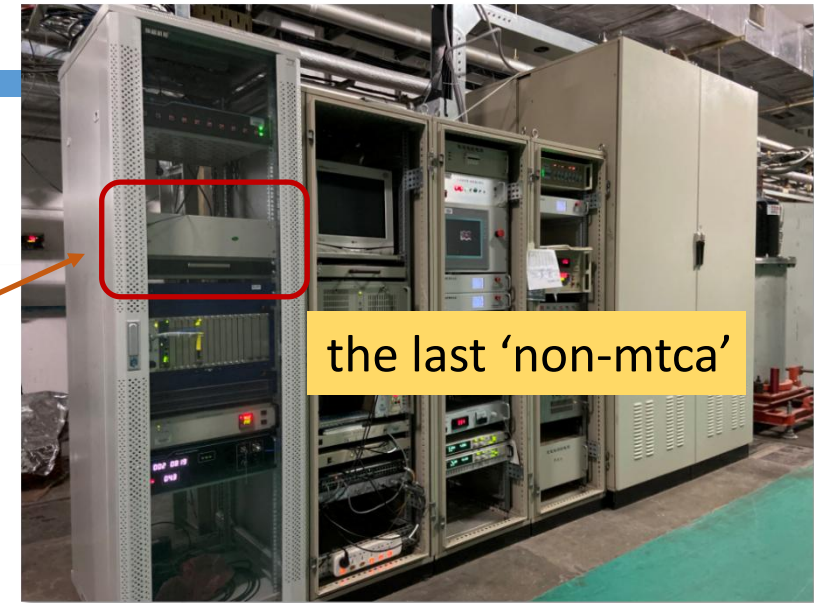
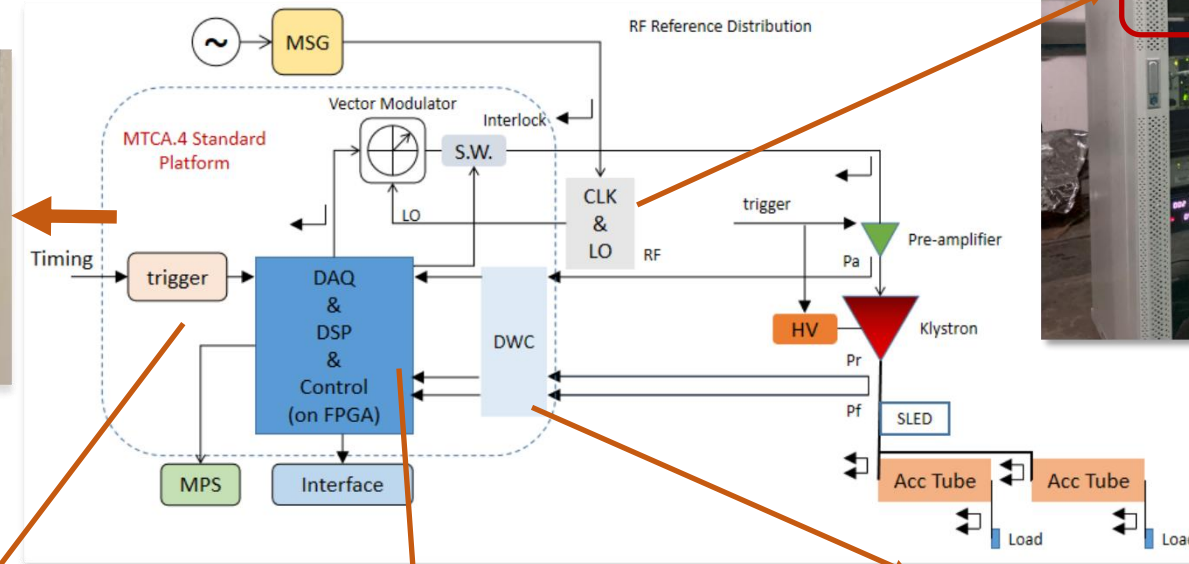


Motivation

- Besides, our MTCA hardware: .



HEPS chassis (3U/2U/9U)



the last 'non-mtca'



In-house made Trig/DIO



DAQ controller



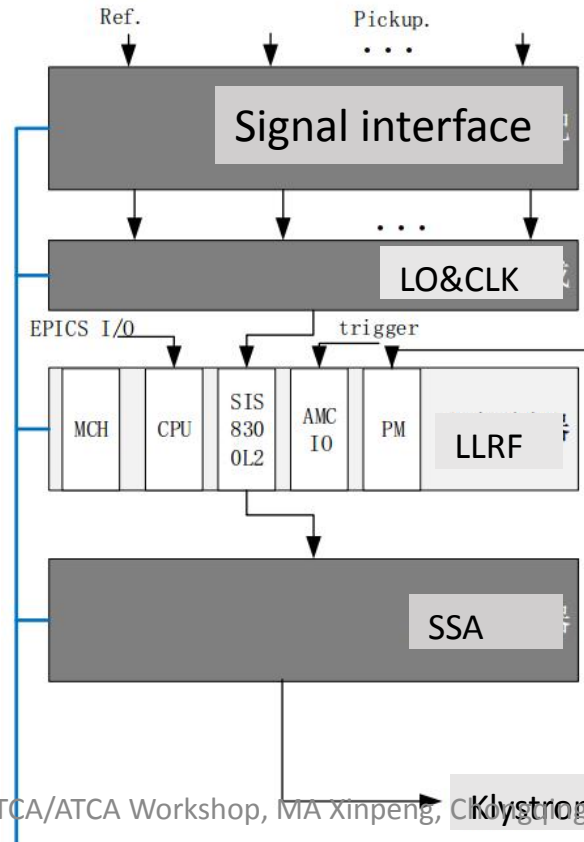
In-house DWC
2998.8MHz



In-house DS
166.6/499.8MHz

Motivation

- our most cases are compact application in small chassis
- one MCH/CPU/PM, 4~6 AMC/RTM boards are sufficient including digital boards, so only 4 LO&CLK are required
- work with our new downconvert RTMs and 2U chassis etc.



front side



rear side

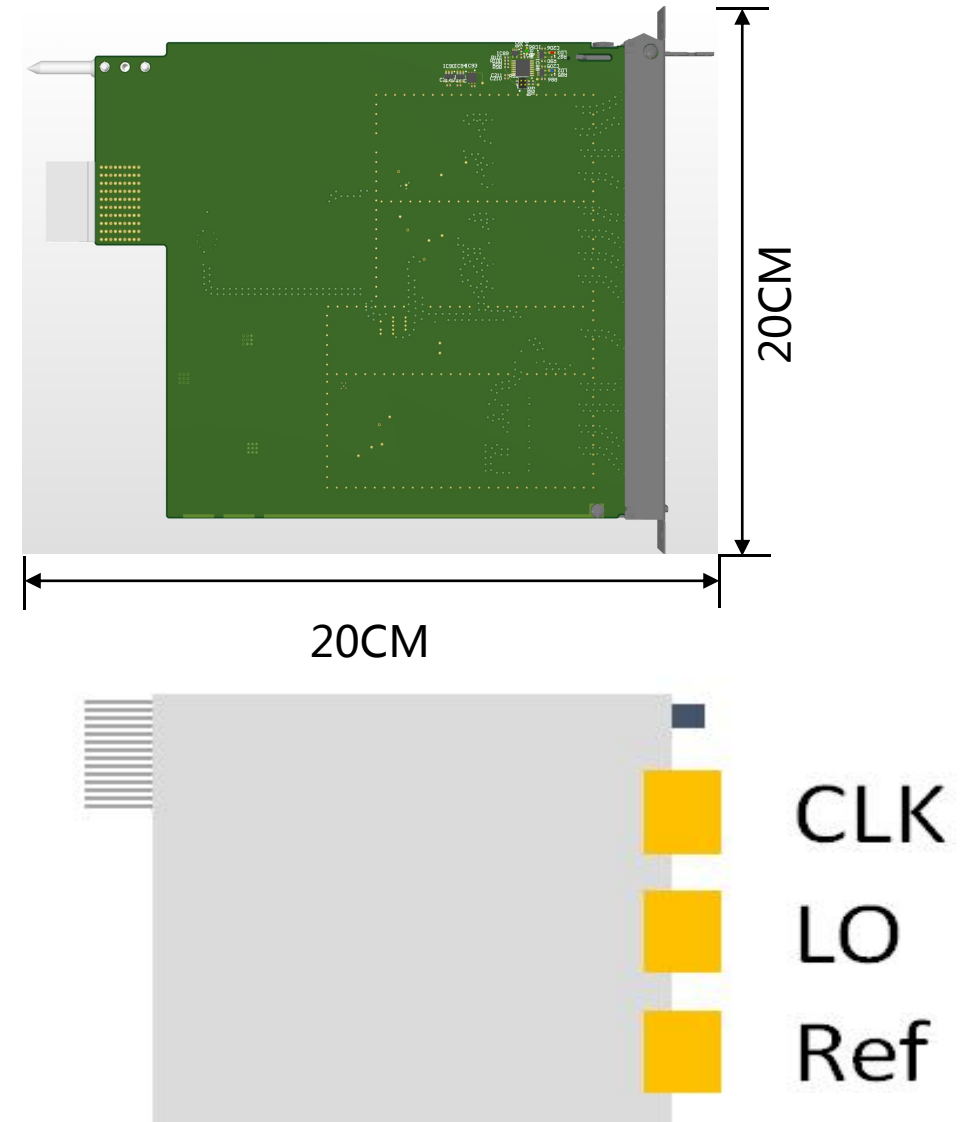


■ Design, progress and status

Design

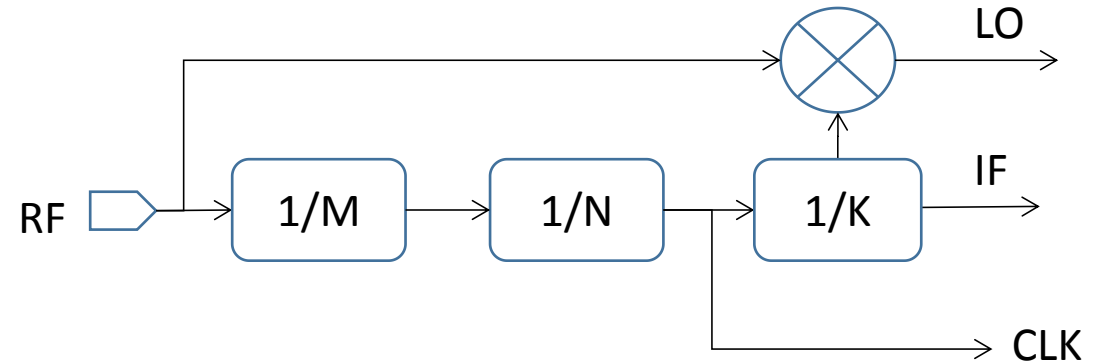
■ Purpose:

- develop one LO&CLK generation and distribution RTM board, compatible with existed DWC-RTM and 2U/3U chassis
- 1 RF Reference input
- Generate **3 types frequencies**, each type distribute out **4 channels**, for maximum 4 DWC applications



Design

- LLRF frequencies choice(LO/CLK/IF):
 - I/Q sampling is enough for most cases, as phase relation is easy to restore
 - all the **IF/CLK ratio** is tried to be the same in design period so that the firmware and software could be remain the same
- So only LO/CLK-RTM board need modified, DAQ-AMC/DWC-RTM barely change - over lifetime

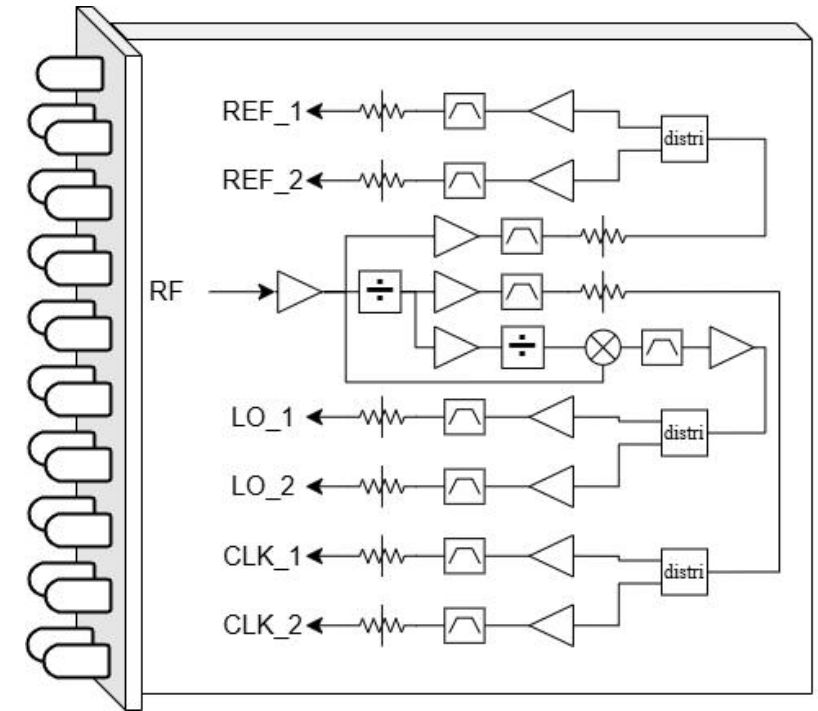
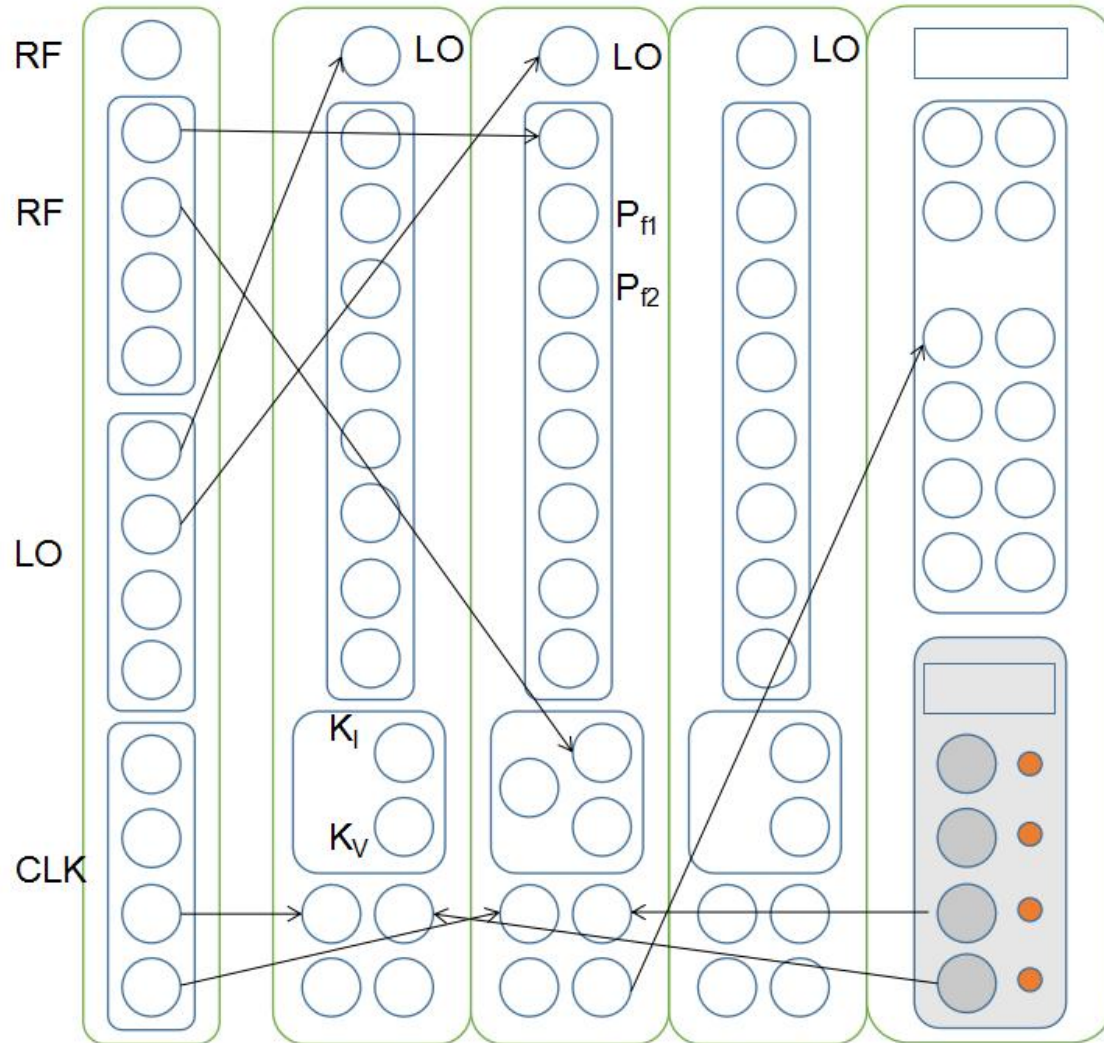


Singals/MHz	M=2 N=14 K=4	M=2 N=15 K=4	M=1 N=13 K=4	M=1/2 N=13 K=4
RF	2998.8	2856	1300	650
LO=RF-IF	2972.025	2832.2	1275	625
CLK	107.1	95.2	100	100
IF	26.775	23.8	25	25
IF/CLK	1/4	1/4	1/4	1/4

Design

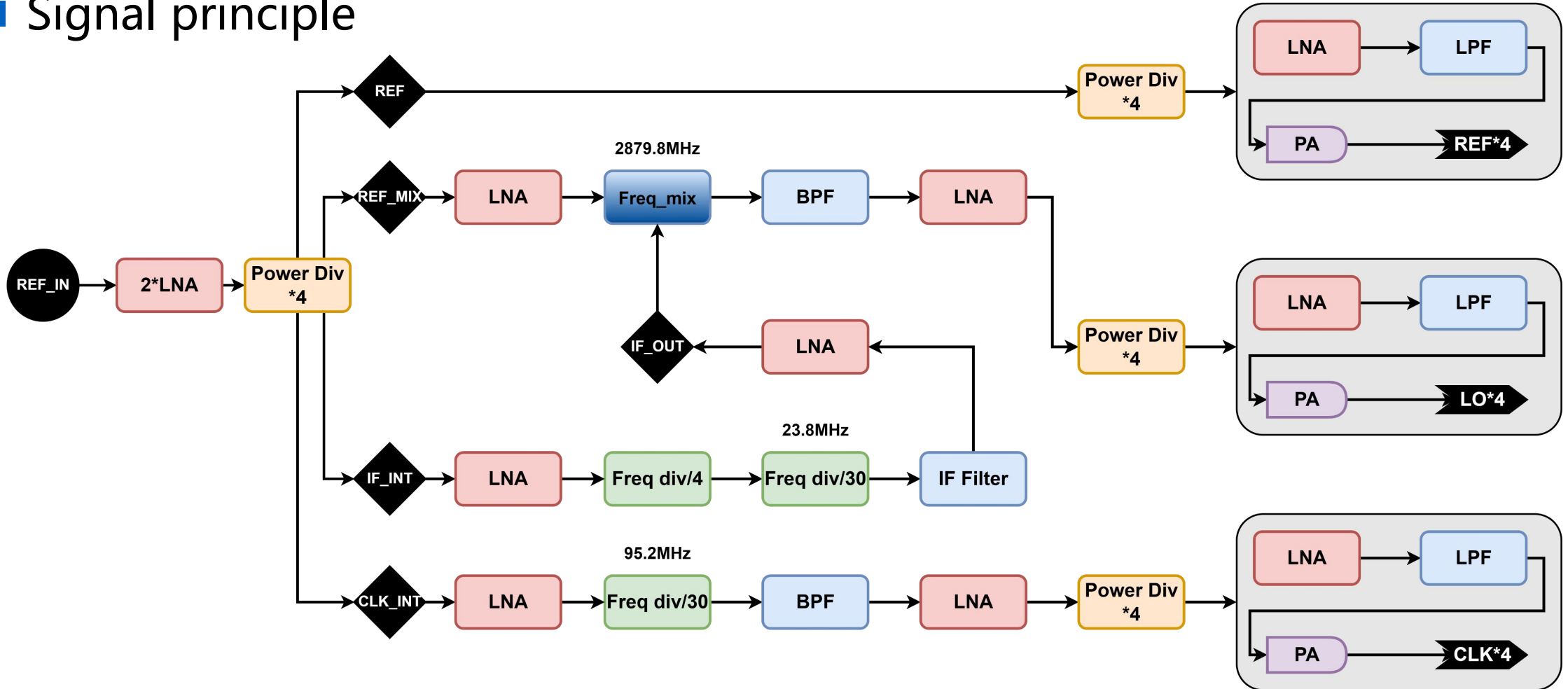
- Main Spec :
 - Ref RF frequency : 2856MHz
 - CLK frequency : 95.2MHz
 - LO frequency : 2879.8MHz
 - input signal level : -10~10dBm
 - output signal level : >13dBm
- Compatible with MicroTCA.4 RTM, supported by MMC protocol with an AMC
- Provide signal power, board status info by I2C bus
- Prototype is 2856MHz, CLK can be suitable for most ADC, $IF/CLK = 1/4$ for I/Q sampling

Design



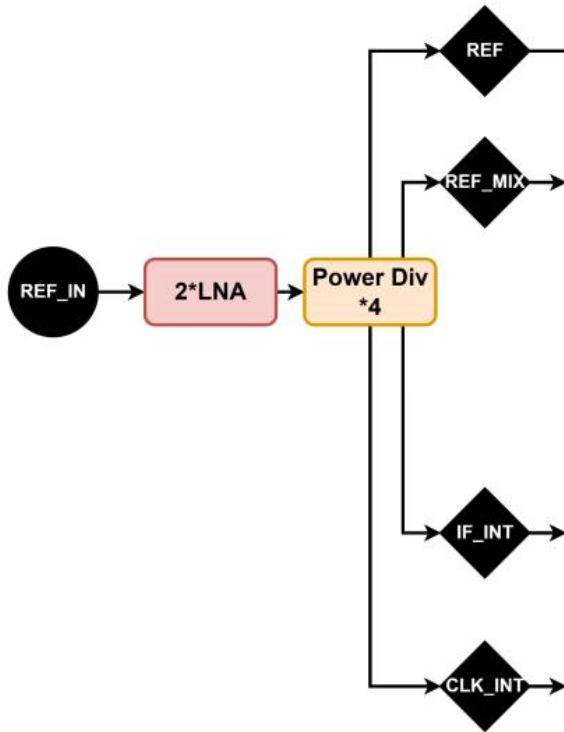
Progress

■ Signal principle

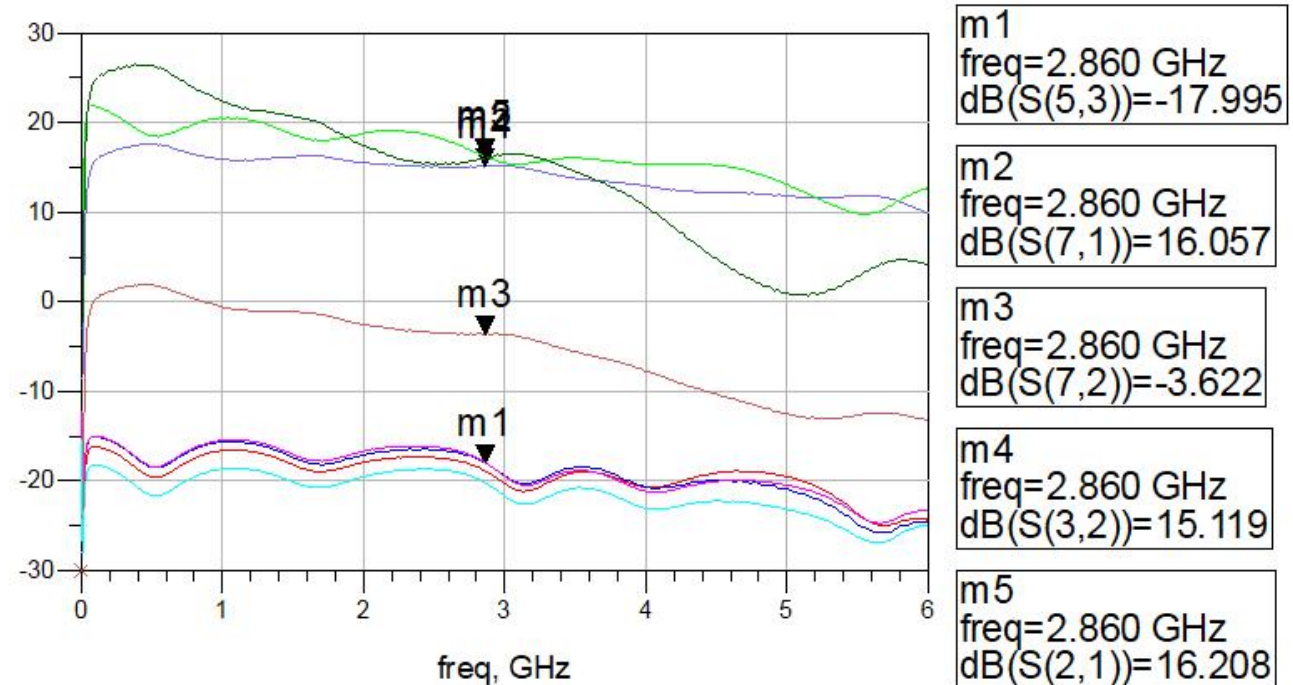


Progress

- Pre-amplifier and divider part S parameter simulation

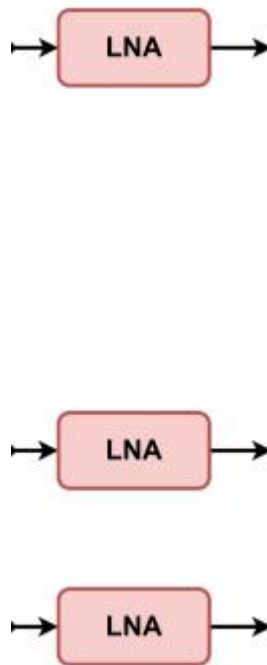


- calculate and evaluate the required power output for each path - ✓

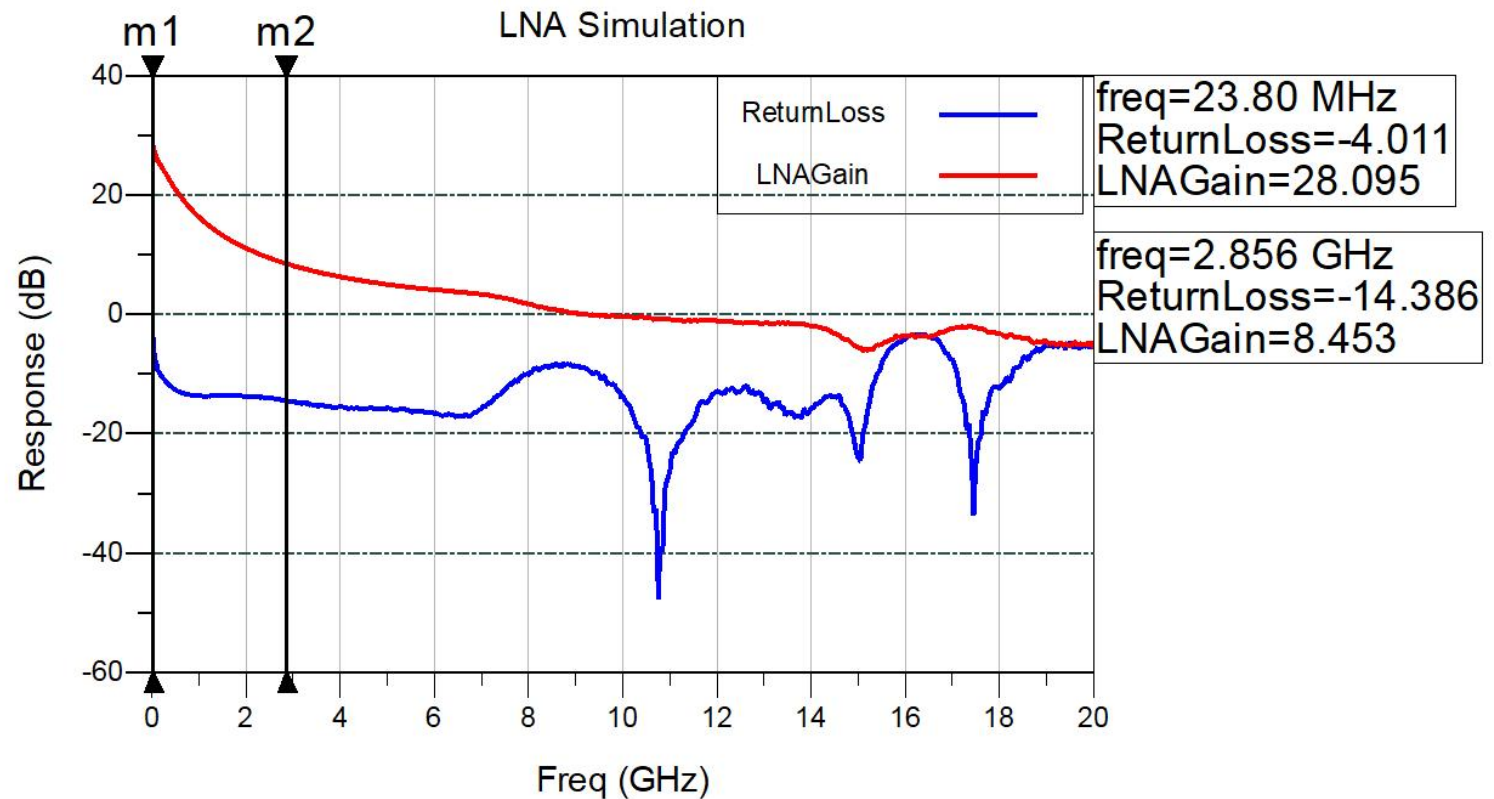


Progress

■ Low noise amplifier
S parameter simulation

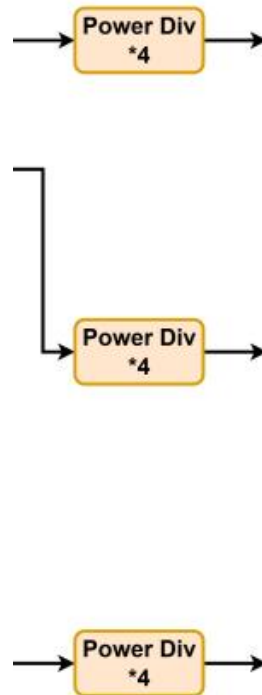


■ Simulate the LNA/attenuator to evaluate
the signal power along - ✓

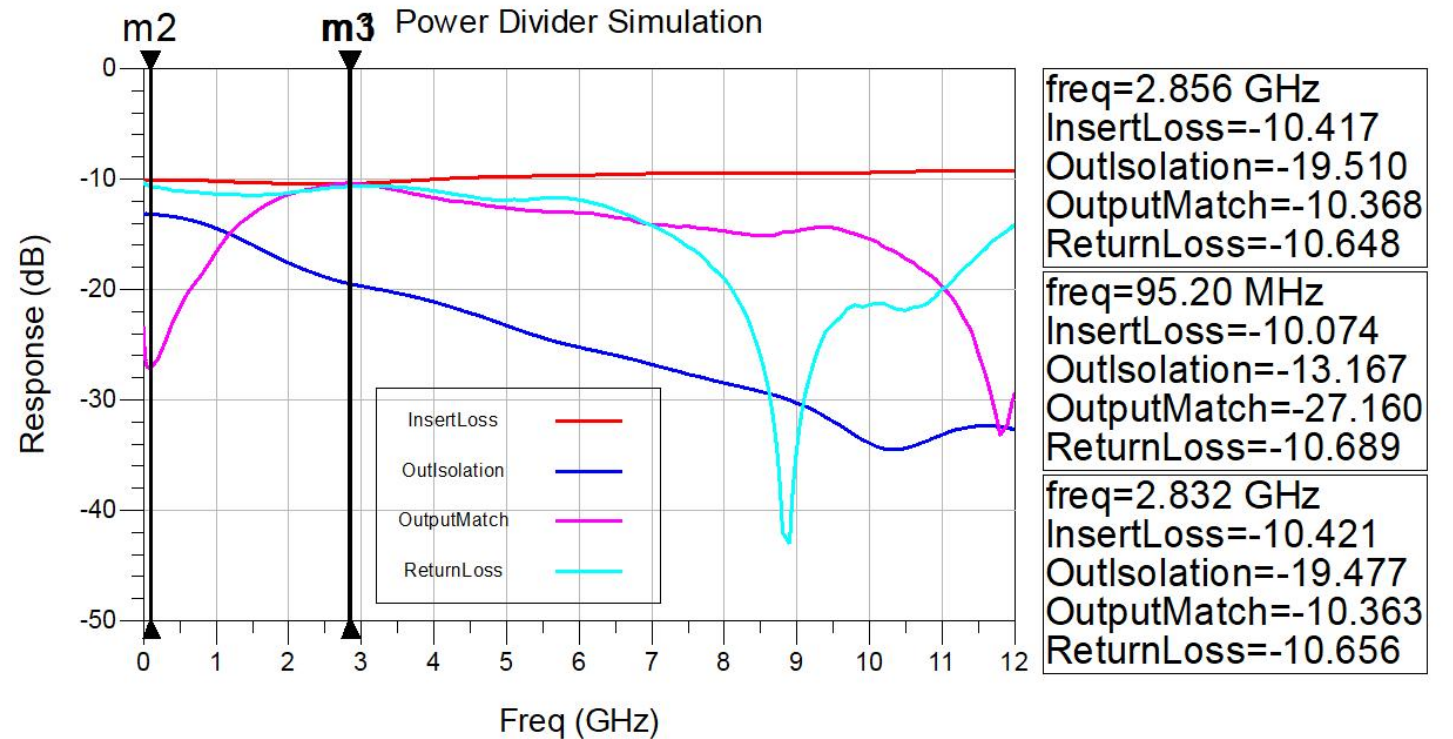


Progress

■ Power divider S parameter simulation

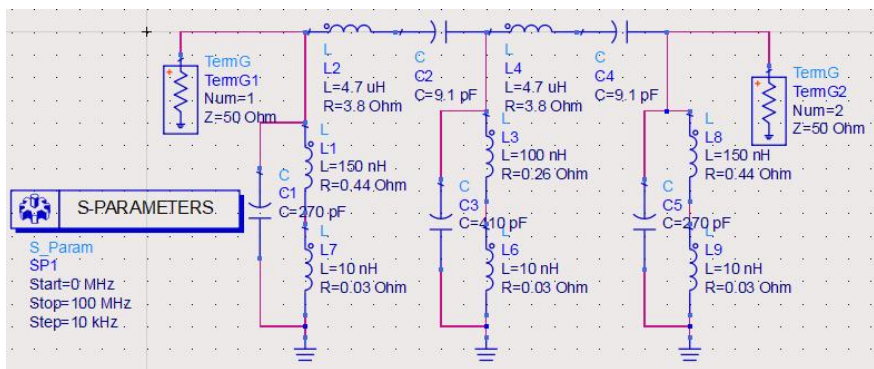
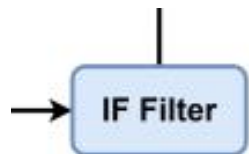


■ Simulate the power divider - ✓

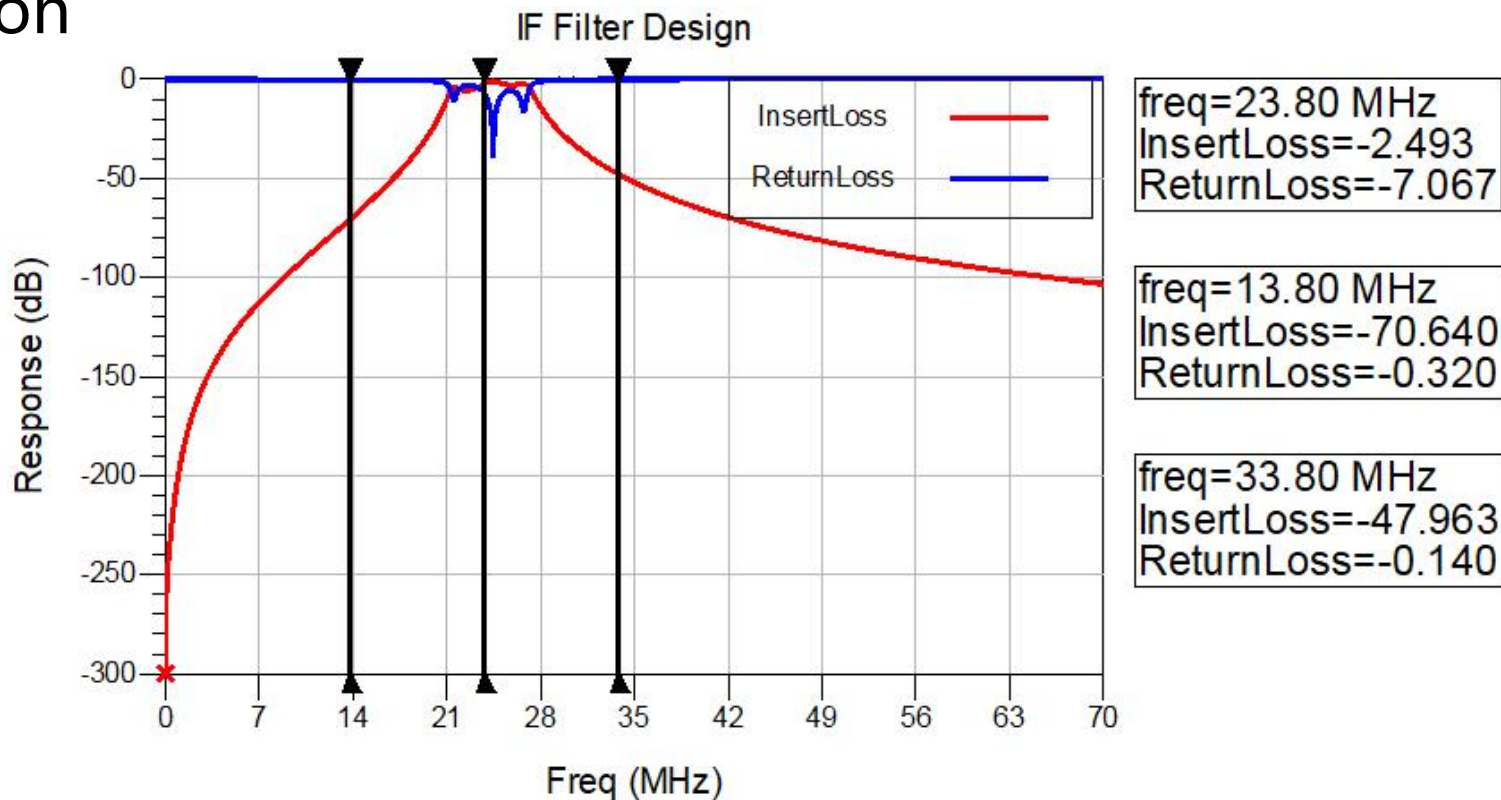


Progress

- IF Band pass filter (23.8MHz, LC type),
S parameter simulation

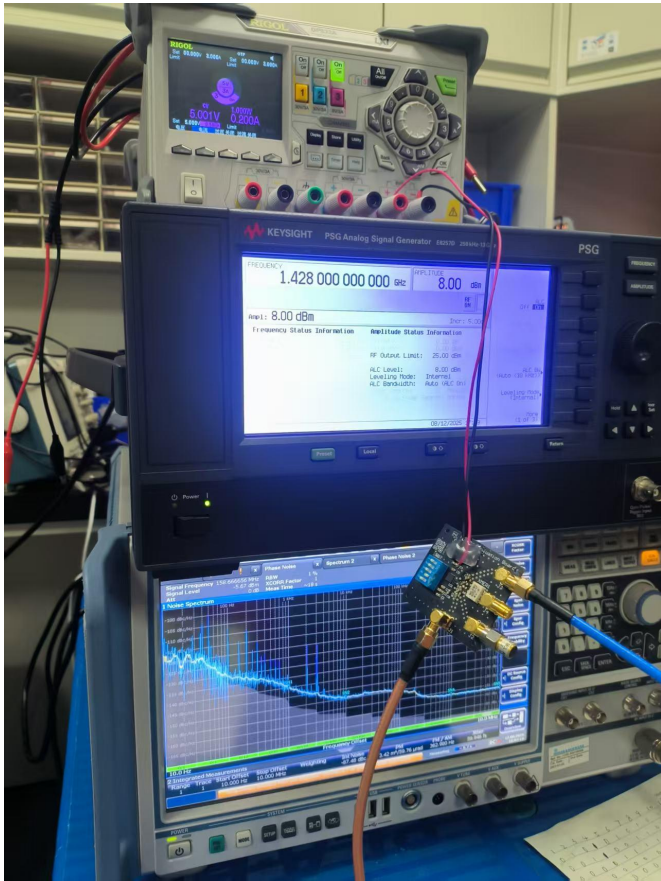
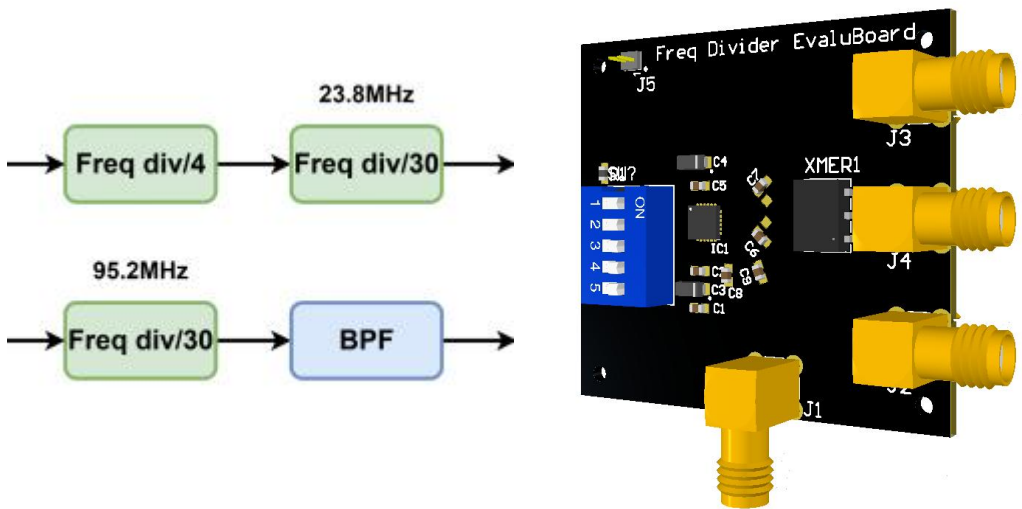


- Simulate the BPF - ✓



Progress

- Frequency divider evaluation
- still under test with harmonic filter, divide number, insertion loss ...



输入: 1428MHz 8dBm 源噪声: 27.54/f _s	
分频率	相位噪声/f _s (10Hz~10MHz)
1	/
2	37.085
3	43.231
4	47.855
5	53.808
6	56.834
7	60.648
8	63.367
9	69.961
10	70.631
11	74.743
12	75.288
13	79.035
14	84.016
15	90.584
16	89.887
17	97.655
18	99.426
19	106.568
20	111.124
21	114.601
22	122.368
23	203.117
24	178.569
25	177.339
26	181.47
27	178.267
28	179.904
29	198.727
30	193.528
31	197.484
32	209.469

Progress

- Evaluate several used low noise amplifier (LNA)
- Mostly use PGA103 from Mini-circuit ✓



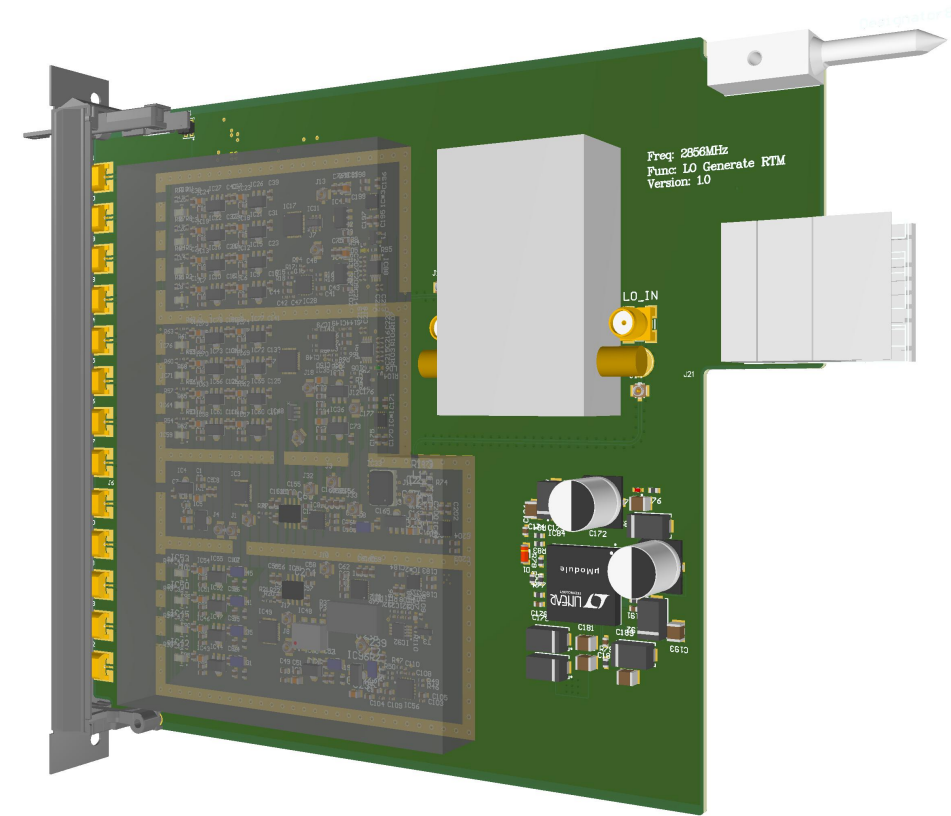
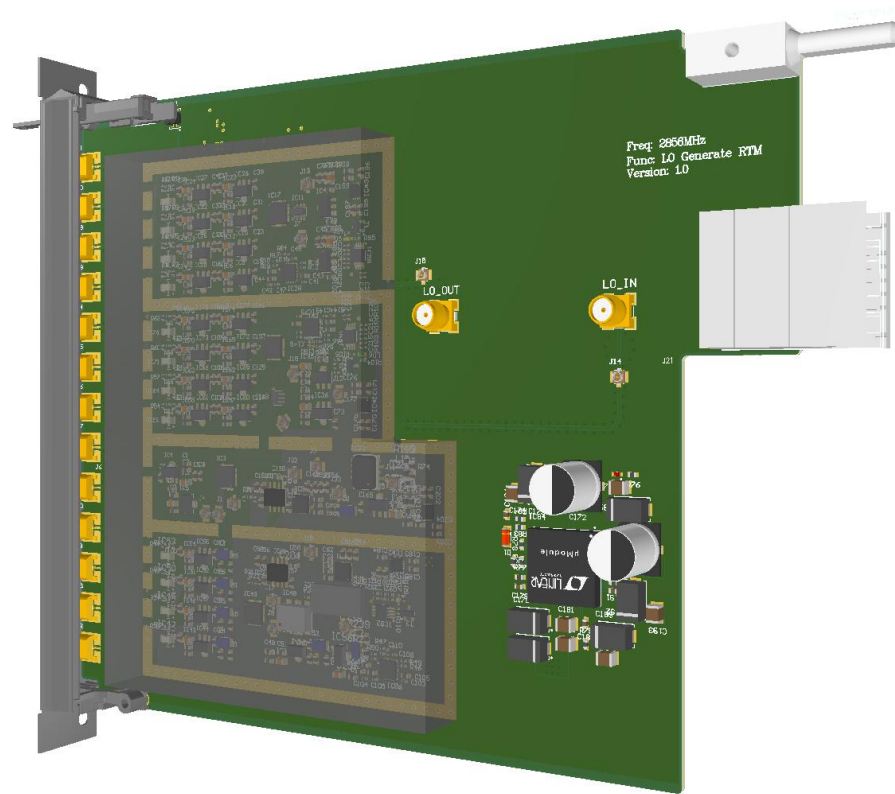
e.g. 499.8MHz jitter 10Hz-
10M/1M/100kHz: 21.4/20.2/16.4fs

Chip	Freq/MHz	Gain/dB	jitter/fs/ /10Hz-10MHz	Vendor
SPF5122Z	166.6	24	40	Qorvo
	499.8	30	20	
SPF5189Z	166.6	25	34	Qorvo
	499.8	19	35	
	2998.8	5	18	
ZX60-P103LN+	166.6	15	34	Mini-circuit
	499.8	11	22	

Status

PCB 3D

- principle design
- key chip Select
- schematic draw
- layout
- matching
- EMI shielding
- power supply tree
- connectors
- MMC



Next steps

- 2025Sep. PCB in production
- then test, debug, basic function verification
- 2025Q4. version 2 design starts, add temperature control, reoptimization
- 2026Q1. upgraded PCB in production
- 2026Q2. board complete, starts to install on test facility

Future plans

- Make more efforts on the firmware and software of new MTCA boards
- Extend to broader band and other frequencies
- Build an open webpage about basic introduction and knowledge

Thank you for your attention!